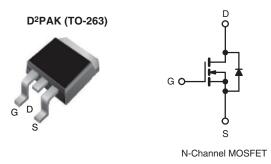
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY							
V _{DS} (V) at T _J max.	550						
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.243					
Q _g max. (nC)	66						
Q _{gs} (nC)	8						
Q _{gd} (nC)	14						
Configuration	Sing	le					



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION Package D²PAK (TO-263) Lead (Pb)-free and Halogen-free SiHB15N50E-GE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	500	V		
Gate-Source Voltage	V _{GS}	± 30			
Continuous Drain Current (T ₁ = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I _D	14.5	
Continuous Drain Current $(1) = 150^{\circ}$ C)	V _{GS} at 10 V			9.2	А
Pulsed Drain Current ^a	I _{DM}	28			
Linear Derating Factor		1.25	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	136	mJ	
Maximum Power Dissipation		PD	156	W	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$			d\//dt	70	V/ns
Reverse Diode dV/dt ^d		dV/dt	27	v/ns	
Soldering Recommendations (Peak Temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.1 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.8	0/10			

S15-0278-Rev. B, 23-Feb-15

For technical questions, contact: hvm@vishav.com

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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•		<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μΑ	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.62	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
	I _{GSS}		$V_{GS} = \pm 20 V$			± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μA
Zene Oete Maltere Ducie Original	I _{DSS}	V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	10	
Zero Gate Voltage Drain Current		V _{DS} = 400 \	-	-	25	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7.5 A	-	0.243	0.280	Ω
Forward Transconductance		V _{DS}	= 30 V, I _D = 7.5 A	-	3.9	-	S
Dynamic					•		<u> </u>
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	1162	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	51	-	-
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	7	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}				55	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$	/ to 400 V, V _{GS} = 0 V	-	164	-	1
Total Gate Charge	Qq			-	33	66	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 7.5 A, V _{DS} = 400 V	-	8	-	nC
Gate-Drain Charge	Q _{qd}			-	14	-	
Turn-On Delay Time	t _{d(on)}			-	15	30	1
Rise Time	t _r	Vee -	= 400 V, I _D = 12 A,	-	24	48	1
Turn-Off Delay Time	t _{d(off)}		$= 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$	-	34	68	ns
Fall Time	t _f		5	-	18	36	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.85	-	Ω
Drain-Source Body Diode Characteristic	s	<u>.</u>					
Continuous Source-Drain Diode Current	IS	MOSFET sym showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	14.5	
Pulsed Diode Forward Current	I _{SM}	U			-	28	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 7.5 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	265	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2t$	5 °C, $I_F = I_S = 7.5 \text{ A}$,	-	3.2	-	μC
Reverse Recovery Current	I _{BBM}		$dl/dt = 100 A/\mu s, V_R = 25 V$		23	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

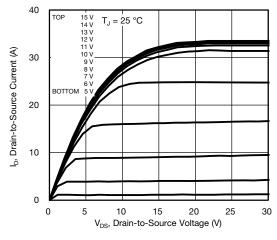


Fig. 1 - Typical Output Characteristics

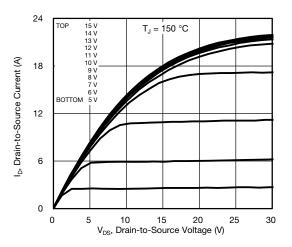


Fig. 2 - Typical Output Characteristics

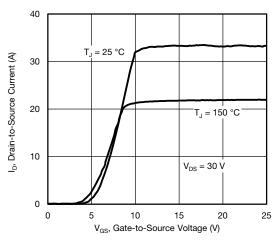


Fig. 3 - Typical Transfer Characteristics

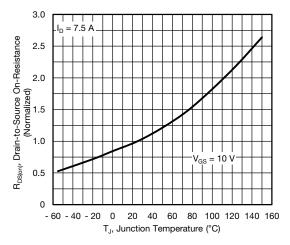


Fig. 4 - Normalized On-Resistance vs. Temperature

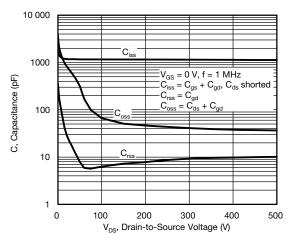


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

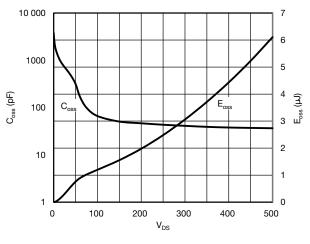


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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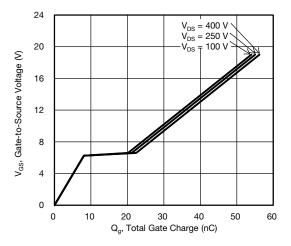


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

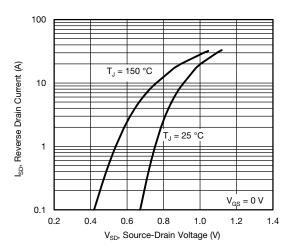
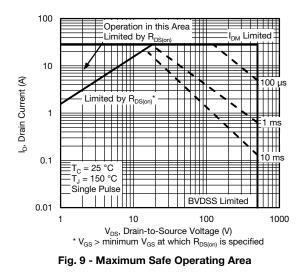


Fig. 8 - Typical Source-Drain Diode Forward Voltage



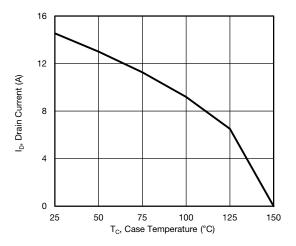


Fig. 10 - Maximum Drain Current vs. Case Temperature

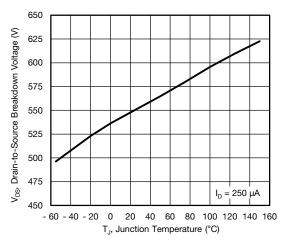


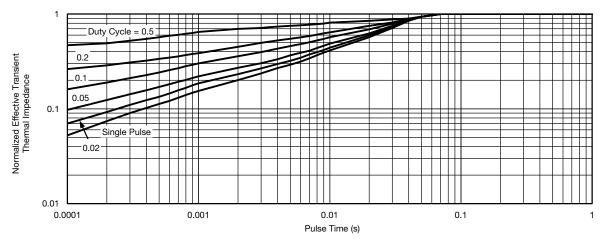
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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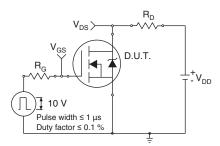


Fig. 13 - Switching Time Test Circuit

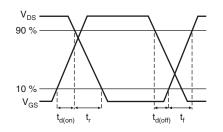


Fig. 14 - Switching Time Waveforms

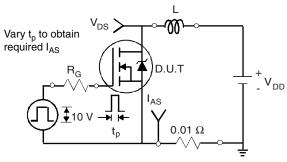


Fig. 15 - Unclamped Inductive Test Circuit

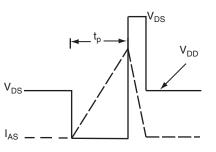


Fig. 16 - Unclamped Inductive Waveforms

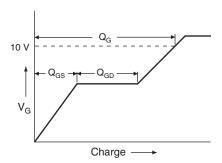
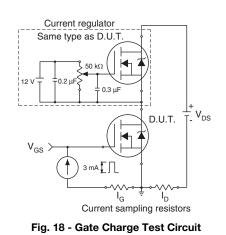


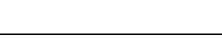
Fig. 17 - Basic Gate Charge Waveform



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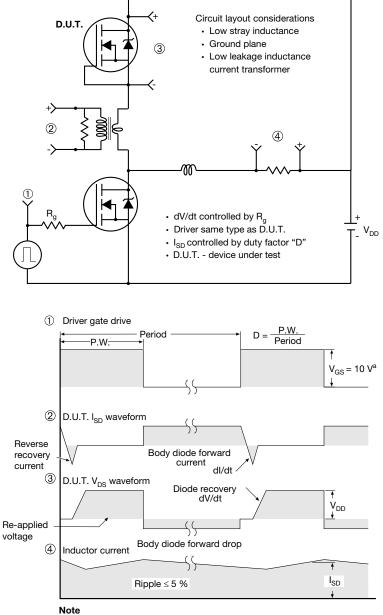
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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SHAY

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

/3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INCHES				MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		F		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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